



# SPECIFICATION FOR APPROVAL

CUSTOMER			
NOMINAL FREQUENCY	40.000000 MHz		
PRODUCT TYPE	TYPE FW 2.0x1.6 SEAM SEALED CRYSTAL		
SPEC. NO. ( P/N )	FW4000045Q		
CUSTOMER P/N			
ISSUE DATE	November 20, 2017		
VERSION	Α		

APPROVED	PREPARED	QA
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# **Diodes Incorporated**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant
- \*AEC-Q200 Compliant

FW4000045Q

VER. A 20-Nov-17

# **VERSION HISTORY**

Version No.	Version Date	Description	Notes
А	Nov.20,2017	Initial Release	

# **FW4000045Q** VER. A 20-Nov-17

## **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	40.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	8	pF	
Calibration Tolerance	FL	±20	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±20	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	Max.
Equivalent Series Resistance	ESR	50	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	МΩ	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



## FW4000045Q

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#### **AEC-Q200 RELIABILITY TEST SPECIFICATIONS:**

#### 1. Initial

1.1 Physical Dimensions: JESD22, Method JB1-100

1.2 External Visual: MIL-STD-883, Method 2009

1.3 Freq. Vs. Temperature: Per Specification/Datasheet

#### 2. Mechanical

2.1 Mechanical Shock: MIL-STD-202 Method 213

2.2 Vibration: MIL-STD-202 Method 204

2.3 Solderability: J-STD-002

2.4 Board Flex: AEC Q200-005

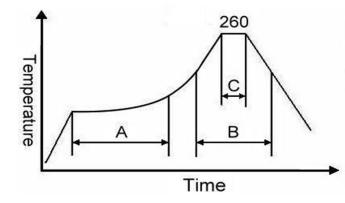
2.5 Terminal Strength (SMD): AEC Q200-006

#### 3.Environmental

- 3.1 Temp Cycle: JESD22, Method JA-104
- 3.2 Resistance to Solder Heat: MIL-STD-202 Method 210
- 3.3 High Temperature Operating Life: MIL-STD-202, Method 108
- 3.4 High Temp Exposure: MIL-STD-202, Method 108
- 3.5 High Temp & High Humidity: MIL-STD-202, Method 103
- 3.6 Thermal Shock: MIL-STD-202, Method 107

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



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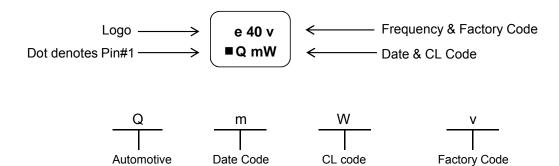
	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec



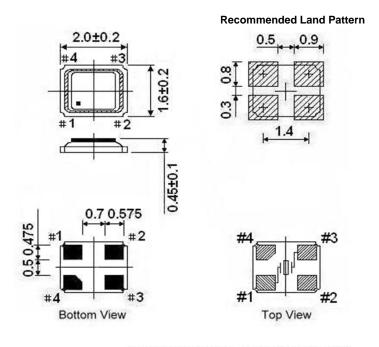
FW4000045Q

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#### **MARKING**



### MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



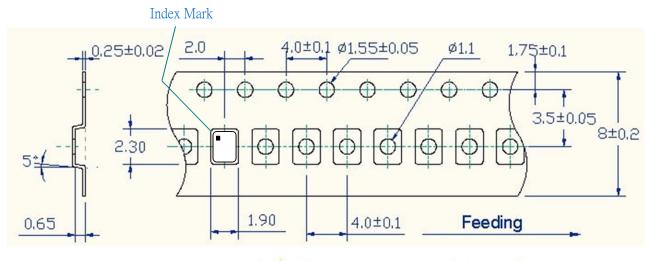
\*\* Recommended - Pin 1 & 3: CRYSTAL Pin 2 & 4: GND

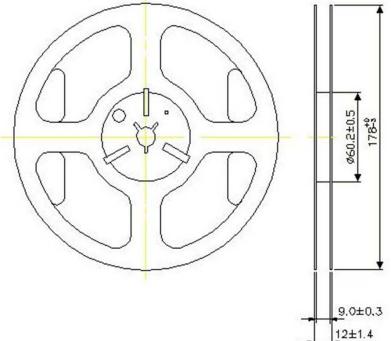
#### Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
  Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.



# Tape & Reel





- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

# **TYPE FW 2.0x1.6 SEAM SEALED CRYSTAL** FW4000045Q VER. A 20-Nov-17 **PACKING Begin** Start **End** 3000pcs-Product Tape Inner Packing Carton Storeroom Label Blue Qualified Label Storeroom Storeroom Label Deliver Packing Carton (L29\*W24\*H30) Green Qualified Label

